Single 2-Input OR Gate

MC74HC1G32

The MC74HC1G32 is a high speed CMOS 2-input OR gate fabricated with silicon gate CMOS technology.

The internal circuit is composed of multiple stages, including a buffer output which provides high noise immunity and stable output.

The MC74HC1G32 output drive current is 1/2 compared to MC74HC series.

Features

- High Speed: $t_{PD} = 7 \text{ ns (Typ)}$ at $V_{CC} = 5 \text{ V}$
- Low Power Dissipation: $I_{CC} = 1 \mu A$ (Max) at $T_A = 25^{\circ}C$
- High Noise Immunity
- Balanced Propagation Delays $(t_{pLH} = t_{pHL})$
- Symmetrical Output Impedance ($I_{OH} = I_{OL} = 2 \text{ mA}$)
- Chip Complexity: < 100 FETs
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

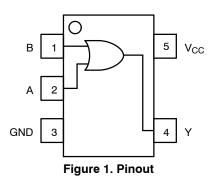




Figure 2. Logic Symbol

| PIN ASSIGNMENT | | | | | |
|----------------|-----------------|--|--|--|--|
| 1 | В | | | | |
| 2 | А | | | | |
| 3 | GND | | | | |
| 4 | Υ | | | | |
| 5 | V _{CC} | | | | |



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SC-88A DF SUFFIX CASE 419A



MARKING



TSOP-5 DT SUFFIX CASE 483



XX = Device CodeM = Date Code* = Pb-Free Package

(Note: Microdot may be in either location)
*Date Code orientation and/or position may vary
depending upon manufacturing location.



CASE 318BQ



XXX = Specific Device Code

(Note: Microdot may be in either location)

FUNCTION TABLE

| Inp | uts | Output |
|-----|-----|--------|
| Α | В | Υ |
| L | L | L |
| L | Н | Н |
| Н | L | Н |
| Н | Н | Н |

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data

MAXIMUM RATINGS

| Symbol | Parameter | Parameter | | | |
|-------------------------------------|---|--|------------------------------|------|--|
| V _{CC} | DC Supply Voltage | SC-88A (NLV), TSOP-5 SC-88A, SC-74A | -0.5 to +7.0 -0.5 to +6.5 | V | |
| V _{IN} | DC Input Voltage | | -0.5 to V _{CC} +0.5 | V | |
| V _{OUT} | DC Output Voltage | | -0.5 to V _{CC} +0.5 | V | |
| I _{IK} | DC Input Diode Current | | ±20 | mA | |
| I _{OK} | DC Output Diode Current | | ±20 | mA | |
| I _{OUT} | DC Output Source/Sink Current | | ±12.5 | mA | |
| I _{CC} or I _{GND} | DC Supply Current per Supply Pin or Ground Pin | | ±25 | mA | |
| T _{STG} | Storage Temperature Range | | -65 to +150 | °C | |
| TL | Lead Temperature, 1 mm from Case for 10 Seconds | | 260 | °C | |
| TJ | Junction Temperature Under Bias | | +150 | °C | |
| $\theta_{\sf JA}$ | Thermal Resistance (Note 1) | SC-88A SC-74A | 377 320 | °C/W | |
| P_{D} | Power Dissipation in Still Air at 85°C | SC-88A SC-74A | 332 390 | mW | |
| MSL | Moisture Sensitivity | | Level 1 | | |
| F _R | Flammability Rating | Oxygen Index: 28 to 34 | UL 94 V-0 @ 0.125 in | | |
| V _{ESD} | ESD Withstand Voltage (Note 2) | Human Body Model Charged Device Model | 2000 1000 | V | |
| I _{LATCHUP} | Latchup Performance (Note 3) | SC-88A (NLV), TSOP-5 SC-88A, SC-74A | ±500 ±100 | mA | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 20 ounce copper trace with no air flow per JESD51-7.
 HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued per JEDEC/JEP172A.

^{3.} Tested to EIA/JESD78 Class II.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit |
|---------------------------------|--|-------------------|---------------------------|------|
| V _{CC} | DC Supply Voltage | 2.0 | 6.0 | V |
| V _{IN} | DC Input Voltage | 0.0 | V _{CC} | V |
| V _{OUT} | DC Output Voltage | 0.0 | V _{CC} | V |
| T _A | Operating Temperature Range | -55 | +125 | °C |
| t _r , t _f | Input Rise and Fall Time $SC-88A \ (NLV), \ TSOP-V_{CC}=2.0 \\ V_{CC}=3.0 \\ V_{CC}=4.5 \\ V_{CC}=6.0$ | V 0 V 0 V 0 | 1000 600 500 400 | ns |
| | Input Rise and Fall Time $SC-88A, SC-74\\ V_{CC}=2.0\\ V_{CC}=2.3\ V\ to\ 2.7\\ V_{CC}=3.0\ V\ to\ 3.6\\ V_{CC}=4.5\ V\ to\ 6.0$ | V 0 V 0 V 0 | 20 20 10 5 | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

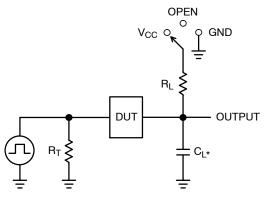
| | | | v _{cc} | Ţ | A = 25° | С | -40°C ≤ 1 | Γ _A ≤ 85°C | -55°C ≤ T | A ≤ 125°C | |
|-----------------|------------------------------|---|--------------------------|----------------------------|--------------------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|------|
| Symbol | Parameter | Test Conditions | (V) | Min | Тур | Max | Min | Max | Min | Max | Unit |
| V _{IH} | High-Level Input Voltage | | 2.0 3.0 4.5 6.0 | 1.5 2.1 3.15 4.20 | - - - | - - - | 1.5 2.1 3.15 4.20 | - - - - | 1.5 2.1 3.15 4.20 | - - - - | V |
| V _{IL} | Low-Level Input Voltage | | 2.0 3.0 4.5 6.0 | - - - | - - - | 0.5 0.9 1.35 1.80 | - - - - | 0.5 0.9 1.35 1.80 | - - - - | 0.5 0.9 1.35 1.80 | V |
| V _{OH} | High-Level Output Voltage | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OH} = -20 \mu A$ | 2.0 3.0 4.5 6.0 | 1.9 2.9 4.4 5.9 | 2.0 3.0 4.5 6.0 | | 1.9 2.9 4.4 5.9 | - - - - | 1.9 2.9 4.4 5.9 | - - - - | V |
| | | $V_{IN} = V_{IH}$ or V_{IL} $I_{OH} = -2$ mA $I_{OH} = -2.6$ mA | 4.5 6.0 | 4.18 5.68 | 4.31 5.80 | 1 1 | 4.13 5.63 | - - | 4.08 5.58 | - - | |
| V _{OL} | Low-Level Output Voltage | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OL} = 20 \mu\text{A}$ | 2.0 3.0 4.5 6.0 | - - - | 0.0 0.0 0.0 0.0 | 0.1 0.1 0.1 0.1 | - - - | 0.1 0.1 0.1 0.1 | - - - | 0.1 0.1 0.1 0.1 | ٧ |
| | | $V_{IN} = V_{IH}$ or V_{IL} $I_{OL} = 2 \text{ mA}$ $I_{OL} = 2.6 \text{ mA}$ | 4.5 6.0 | - | 0.17 0.18 | 0.26 0.26 | - - | 0.33 0.33 | - - | 0.40 0.40 | |
| I _{IN} | Input Leakage Current | V _{IN} = 6.0 V or GND | 6.0 | - | - | ±0.1 | - | ±1.0 | - | ±1.0 | μΑ |
| I _{CC} | Quiescent Supply Current | V _{IN} = V _{CC} or GND | 6.0 | - | - | 1.0 | - | 10 | - | 40 | μΑ |

AC ELECTRICAL CHARACTERISTICS

| | | | T _A = 25°C | | $-40^{\circ}C \le T_A \le 85^{\circ}C$ | | -55°C ≤ T _A ≤ 125°C | | | |
|--------------------|---------------------------|--|-----------------------|---------------------|--|-------|--------------------------------|-------------|-----------------------|------|
| Symbol | Parameter | Test Conditions | Min | Тур | Max | Min | Max | Min | Max | Unit |
| t _{PLH} , | Propagation Delay, | V _{CC} = 5.0 V C _L = 15 pF | _ | 3.5 | 15 | - | 20 | _ | 25 | ns |
| t _{PHL} | (A or B) to Y | $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | | 20 11 8 7 | 100 27 20 17 | | 125 35 25 21 | - - - | 155 90 35 26 | |
| t _{TLH} , | Output Transition Time | V _{CC} = 5.0 V C _L = 15 pF | _ | 3 | 10 | - | 15 | - | 20 | ns |
| | | $\begin{tabular}{lllllllllllllllllllllllllllllllllll$ | - - - | 25 16 11 9 | 125 35 25 21 | 1 1 1 | 155 45 31 26 | - - - | 200 60 38 32 | |
| C _{IN} | Input Capacitance | | _ | 5 | 10 | _ | 10 | _ | 10 | pF |

| | | Typical @ 25°C, V _{CC} = 5.0 V | |
|----------|--|---|----|
| C_{PD} | Power Dissipation Capacitance (Note 4) | 10 | pF |

^{4.} C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC(OPR)} = C_{PD} • V_{CC} • f_{in} + I_{CC}. C_{PD} is used to determine the no–load dynamic power consumption; P_D = C_{PD} • V_{CC}² • f_{in} + I_{CC} • V_{CC}.



| Test | Switch Position | C _L , pF | R _L , Ω |
|--|--------------------|------------------------------|--------------------|
| t _{PLH} / t _{PHL} | Open | | Х |
| t _{TLH} / t _{THL} (Note 5) | Open | See AC Characteristics Table | Х |
| t _{PLZ} / t _{PZL} | V _{CC} | lable | 1 k |
| t _{PHZ} / t _{PZH} | GND | | 1 k |

X - Don't Care

* C_L includes probe and jig capacitance R_T is Z_{OUT} of pulse generator (typically 50 W) f = 1 MHz

Figure 3. Test Circuit

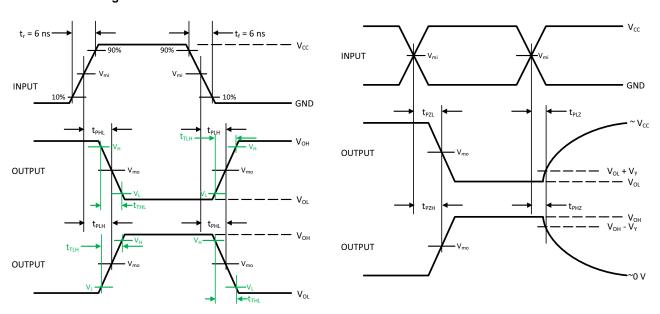


Figure 4. Switching Waveforms

| | | V _{mo} , V | | | | |
|---------------------|---------------------|-------------------------------------|--------------------------------------|--|--|-------------|
| V _{CC} , V | V _{mi} , V | t _{PLH} , t _{PHL} | $t_{PZL}, t_{PLZ}, t_{PZH}, t_{PHZ}$ | V_L, V | V _H , V | V_Y , V |
| 3.0 to 3.6 | V _{CC} /2 | V _{CC} /2 | V _{CC} /2 | V _{OL} + 0.1 (V _{OH} – V _{OL}) | V _{OL} + 0.9 (V _{OH} – V _{OL}) | 0.3 |
| 4.5 to 5.5 | V _{CC} /2 | V _{CC} /2 | V _{CC} /2 | V _{OL} + 0.1 (V _{OH} – V _{OL}) | V _{OL} + 0.9 (V _{OH} – V _{OL}) | 0.3 |

^{5.} t_{TLH} and t_{THL} are measured from 10% to 90% of (V_{OH} – V_{OL}), and 90% to 10% of (V_{OH} – V_{OL}), respectively.

ORDERING INFORMATION

| Device | Packages | Specific Device Code | Pin 1 Orientation (See below) | Shipping [†] |
|-------------------|----------|----------------------|----------------------------------|-----------------------|
| MC74HC1G32DFT1G | SC-88A | H4 | Q2 | 3000 / Tape & Reel |
| NLVHC1G32DFT1G* | SC-88A | H4 | Q2 | 3000 / Tape & Reel |
| MC74HC1G32DFT2G | SC-88A | H4 | Q4 | 3000 / Tape & Reel |
| NLVHC1G32DFT2G* | SC-88A | H4 | Q4 | 3000 / Tape & Reel |
| MC74HC1G32DTT1G | TSOP-5 | H4 | Q4 | 3000 / Tape & Reel |
| NLV74HC1G32DTT1G* | TSOP-5 | H4 | Q4 | 3000 / Tape & Reel |
| MC74HC1G32DBVT1G | SC-74A | H4 | Q4 | 3000 / Tape & Reel |

[†]For complete information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Pin 1 Orientation in Tape and Reel

Direction of Feed

Q4 Q3

Q4 Q3

^{*}NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.



DATE 18 JAN 2018







RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME
 Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
 THICKNESS. MINIMUM LEAD THICKNESS IS THE
 MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

| | MILLIMETERS | | | | |
|-----|-------------|------|--|--|--|
| DIM | MIN | MAX | | | |
| Α | 0.90 | 1.10 | | | |
| A1 | 0.01 | 0.10 | | | |
| b | 0.25 | 0.50 | | | |
| С | 0.10 | 0.26 | | | |
| D | 2.85 | 3.15 | | | |
| E | 2.50 | 3.00 | | | |
| E1 | 1.35 | 1.65 | | | |
| е | 0.95 BSC | | | | |
| L | 0.20 | 0.60 | | | |
| М | 0 ° | 10° | | | |

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

Μ = Date Code = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

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SC-88A (SC-70-5/SOT-353) CASE 419A-02 **ISSUE L**

DATE 17 JAN 2013



- TES:
 DIMENSIONING AND TOLERANCING
 PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
 419A-01 OBSOLETE. NEW STANDARD 3.
- 419A-02.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

| | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.071 | 0.087 | 1.80 | 2.20 |
| В | 0.045 | 0.053 | 1.15 | 1.35 |
| С | 0.031 | 0.043 | 0.80 | 1.10 |
| D | 0.004 | 0.012 | 0.10 | 0.30 |
| G | 0.026 BSC | | 0.65 BSC | |
| Н | | 0.004 | | 0.10 |
| J | 0.004 | 0.010 | 0.10 | 0.25 |
| K | 0.004 | 0.012 | 0.10 | 0.30 |
| N | 0.008 REF | | 0.20 REF | |
| S | 0.079 | 0.087 | 2.00 | 2.20 |

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.



0.50 0.0197 0.65 0.025 0.65 0.025 0.40 0.0157 1.9 mm 0.0748 SCALE 20:1

SOLDER FOOTPRINT

| STYLE 1: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR | STYLE 2: PIN 1. ANODE 2. EMITTER 3. BASE 4. COLLECTOR 5. CATHODE | STYLE 3: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. CATHODE 1 | STYLE 4: PIN 1. SOURCE 1 2. DRAIN 1/2 3. SOURCE 1 4. GATE 1 5. GATE 2 | STYLE 5: PIN 1. CATHODE 2. COMMON ANODE 3. CATHODE 2 4. CATHODE 3 5. CATHODE 4 |
|--|--|--|--|--|
| | | | | |

| 5. COLLECTOR | 5. CATHODE | 5. CATHODE I | 5. GATE 2 | 5. CATHODE 4 |
|--|--|--|--|---|
| STYLE 6: PIN 1. EMITTER 2 2. BASE 2 3. EMITTER 1 4. COLLECTOR 5. COLLECTOR 2/BASE 1 | STYLE 7: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR | STYLE 8: PIN 1. CATHODE 2. COLLECTOR 3. N/C 4. BASE 5. EMITTER | STYLE 9: PIN 1. ANODE 2. CATHODE 3. ANODE 4. ANODE 5. ANODE | Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment. |

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TSOP-5 **CASE 483 ISSUE N**

DATE 12 AUG 2020









NOTES:

- DIMENSIONING AND TOLERANCING PER ASME
- CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
 THICKNESS. MINIMUM LEAD THICKNESS IS THE
 MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSION A. OPTIONAL CONSTRUCTION: AN ADDITIONAL
- TRIMMED LEAD IS ALLOWED IN THIS LOCATION. TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY.

| | MILLIMETERS | | |
|-----|-------------|------|--|
| DIM | MIN | MAX | |
| Α | 2.85 | 3.15 | |
| В | 1.35 | 1.65 | |
| C | 0.90 | 1.10 | |
| D | 0.25 | 0.50 | |
| G | 0.95 BSC | | |
| Н | 0.01 | 0.10 | |
| J | 0.10 | 0.26 | |
| K | 0.20 | 0.60 | |
| М | 0 ° | 10 ° | |
| S | 2.50 | 3.00 | |

SOLDERING FOOTPRINT*



^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*





XXX = Specific Device Code XXX = Specific Device Code

= Assembly Location = Date Code

= Year = Pb-Free Package

= Work Week W

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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NLV74HC02ADR2G 74HC32S14-13 74LS133 74LVC1G32Z-7 M38510/30402BDA 74LVC1G86Z-7 74LVC2G08RA3-7
NLV74HC08ADTR2G NLV74HC14ADR2G NLV74HC20ADR2G NLX2G86MUTCG 5962-8973601DA 74LVC2G02HD4-7
NLU1G00AMUTCG 74LVC2G32RA3-7 74LVC2G00HD4-7 NL17SG02P5T5G 74LVC2G00HK3-7 74LVC2G86HK3-7
NLX1G99DMUTWG NLVVHC1G00DFT2G NLVHC1G08DFT2G NLV7SZ57DFT2G NLV74VHC04DTR2G NLV27WZ86USG
NLV27WZ00USG NLU1G86CMUTCG NLU1G08CMUTCG NL17SZ32P5T5G NL17SZ00P5T5G NL17SH02P5T5G 74AUP2G00RA3-7
NLV74HC02ADTR2G NLX1G332CMUTCG NL17SG86P5T5G NL17SZ05P5T5G